N-Channel SiC Power MOSFET

EASUNOS

RSM120080Z

=

1200 V

80 mΩ

36 A

Features

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- High Blocking Voltage with Low On-Resistance
- High Speed Switching with Low Capacitance
- Easy to Parallel and Simple to Drive

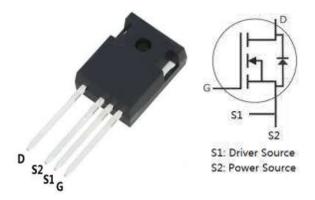
Benefits

- Higher System Efficiency
- Reduced Cooling Requirements
- Increased Power Density
- Increased System Switching Frequency

Applications

- Power Supplies
- High Voltage DC/DC Converters
- Motor Drives
- Switch Mode Power Supplies
- Pulsed Power applications

Package



VDS

R_{DS(on)}

I_D(a)25°C

Part Number	Package		
RSM120080Z	TO-247-4		

Maximum Ratings (Tc=25°C unless otherwise specified)

Symbo I	Parameter	Value	Unit	Test Conditions	Note
V _{DSmax}	Drain-Source Voltage	1200	v	V _{GS} =0V, I _D =100μΑ	
V _{GSmax}	Gate-Source Voltage	-10/+25	v	Absolute maximum values	
V _{GSop}	Gate-Source Voltage	-5/+20	v	Recommended operational values	
		36		V _{GS} =20V, T _c =25°C	
Ι _D	Continuous Drain Current	24	A	V _{GS} =20V, T _c =100°C	
I _{D(pulse)}	Pulsed Drain Current	80	Α	Pulse width t _p limited by T _{Jmax}	
PD	Power Dissipation	192	w	T₀=25°C, T₀=150°C	
TJ, TSTG	Operating Junction and Storage Temperature	-55 to +150	°C		

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<u>RSM120080Z</u>

Electrical Characteristics (T_c=25°C unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions	Note	
V(BR)DSS	Drain-Source Breakdown Voltage	1200	/	/	v	V _{GS} =0V, Ι _D =100μΑ		
		2.0	2.4	4.0	v	$V_{DS}=V_{GS}$, $I_{D}=5 \text{ mA}$	Fig. 11	
V _{GS(th)}	Gate Threshold Voltage	/	1.8	/		V _{DS} =V _{GS} , I _D =5mA, T _J =150°C		
I _{DSS}	Zero Gate Voltage Drain Current	/	1	100	μA	V _{DS} =1200V, V _{GS} =0V		
I _{GSS+}	Gate-Source Leakage Current	/	10	250	nA	V _{DS} =0V, V _{GS} =25V		
I _{GSS-}	Gate-Source Leakage Current	/	10	250	nA	V _{DS} =0V, V _{GS} =-10V		
_		/	80	98		V _{GS} =20V, I _D =20A	Fig.	
R _{DS(on)}	Drain-Source On-State Resistance	/	140	/	mΩ	V _{GS} =20V, I _D =20A, T _J =150°C	4,5,6	
C _{iss}	Input Capacitance	/	1475	/		V _{GS} =0V		
Coss	Output Capacitance	1	94	/	рF	V _{DS} =1000V	Fig.	
C _{rss}	Reverse Transfer Capacitance	/	11	/		f=1MHz	15,1	
E _{oss}	Coss Stored Energy	/	52	/	μ	V _{AC} =25mV		
E _{ON}	Turn-On Switching Energy	/	564	/	_	V _{DS} =800V, V _{GS} =-5V/20V		
E _{OFF}	Turn-Off Switching Energy	1	260	/	μ	I _D =20A, R _{G(ext)} =2.5Ω, L=200μH		
t _{d(on)}	Turn-On Delay Time	/	9.3	/				
tr	Rise Time	/	9.5	/		V _{DS} =800V, V _{GS} =-5V/20V,		
t _{d(off)}	Turn-Off Delay Time	/	18	/	ns	I _D =20A R _{G(ext)} =2.5Ω,		
t _f	Fall Time	/	7.6	/		R _L =40Ω		
R _{G(int)}	Internal Gate Resistance	/	3.1	/	Ω	f=1MHz, V _{AC} =25mV		
Q _{GS}	Gate to Source Charge	/	24	/		V _{DS} =800V		
Q _{GD}	Gate to Drain Charge	/	15	/	nC	V _{GS} =-5V/20V		
Q _G	Total Gate Charge	/	79	/		I _D =20A		

Reverse Diode Characteristics

Symbol	Parameter	Тур.	Max.	Unit	Test Conditions	Note
		3.6	1	v	V _{GS} =-5V, I _{SD} =10A	Fig.
V _{SD}	Diode Forward Voltage	3.3	/	V	V _{GS} =-5V, I _{SD} =10A, T _J =150°C	8,9,10
ls	Continuous Diode Forward Current	1	44	A	T _c =25°C	
t _{rr}	Reverse Recover Time	35	/	ns		
Q _{rr}	Reverse Recovery Charge	91	1	nC	V _R =800V, I _{SD} =20A	
I _{rrm}	Peak Reverse Recovery Current	4.5	/	A		

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Unit	Test Conditions	Note
R _{θJC}	Thermal Resistance from Junction to Case	0.6	1	10 (14)		
R _{θJA}	Thermal Resistance from Junction to Ambient	1	40	°C/W		

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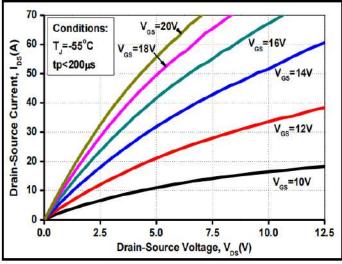


Figure 1. Output Characteristics T_J = -55 °C

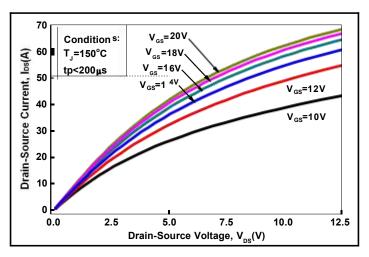
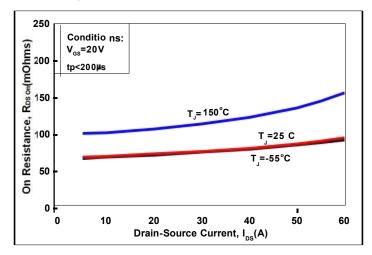
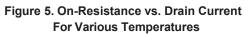
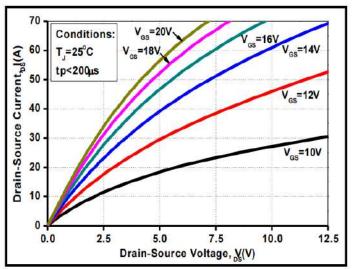
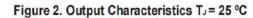


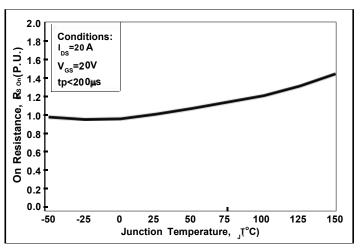
Figure 3. Output Characteristics T_J = 150 °C



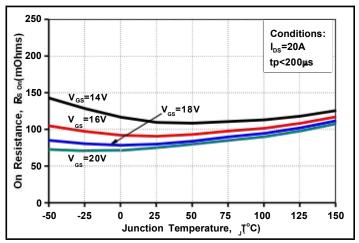


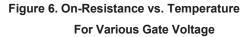












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Typical Performance

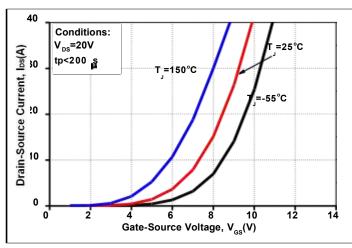
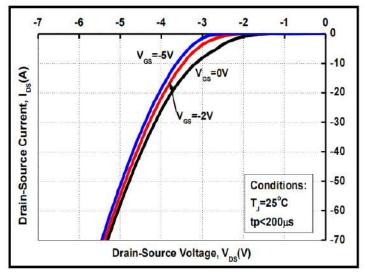
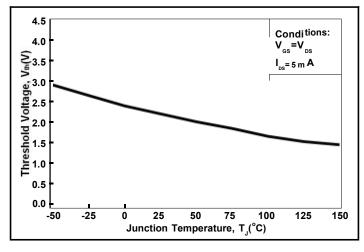


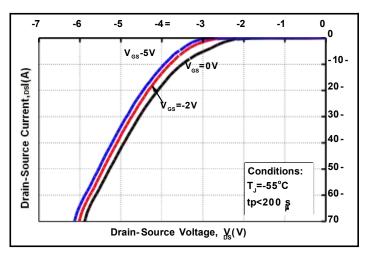
Figure 7. Transfer Characteristic for Various Junction Temperatures

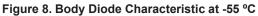


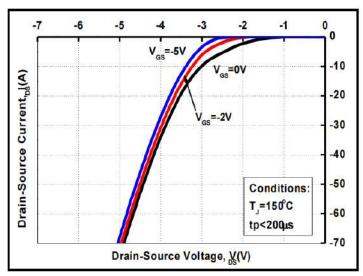




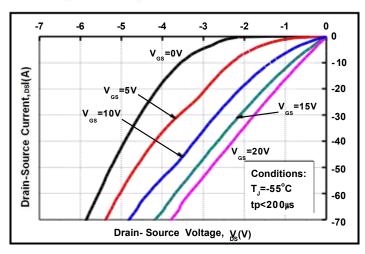














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Typical Performance

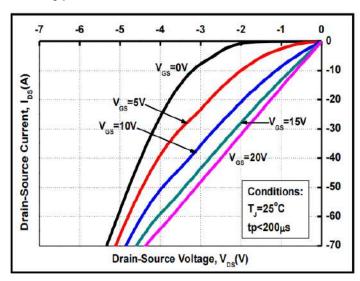


Figure 13. 3rd Quadrant Characteristic at 25 °C

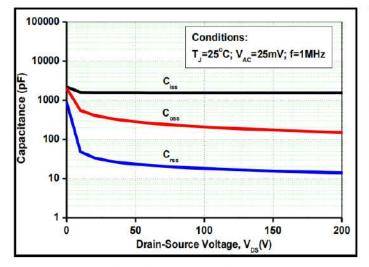
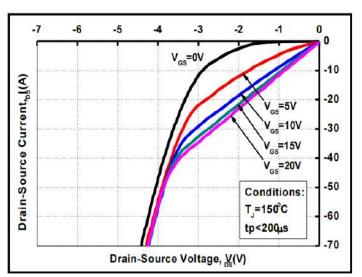


Figure 15. Capacitances vs. Drain-Source Voltage (0 - 200V)





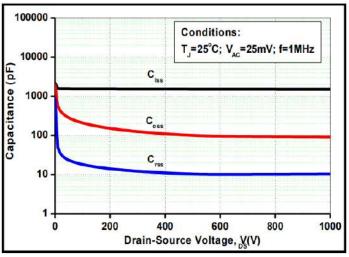


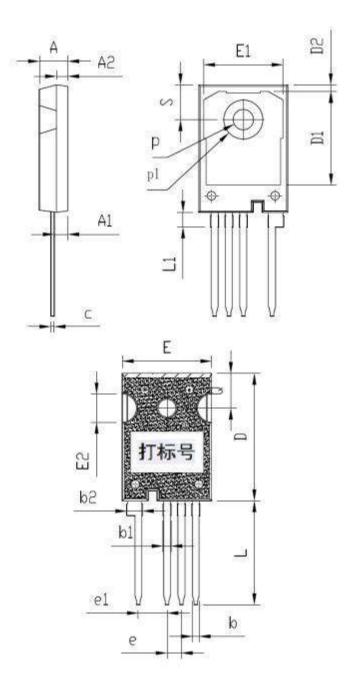
Figure 16. Capacitances vs. Drain-Source Voltage (0 - 1000V)



RSM120080Z

Package Dimensions

Package TO-247-4



	DIMENSIONS IN						
SYMBOLS	MILLMETERS						
	MIN	MAX					
А		5.00					
A1		2.40					
A2		2.00					
b		1.20					
b1		1.30					
b2		2.65					
с		0.6					
D		22.54					
D1		16.50					
D2		1.17					
е		2.54					
e1		5.08					
E		15.80					
E1		14.00					
E2		5.00					
L		18.38					
L1		2.58					
р		3.60					
p1		6.80					
Q		6.15					
S		6.15					

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